

EFC6611R

Power MOSFET for 1-Cell Lithium-ion Battery Protection 12V, 3.2mΩ, 27A, Dual N-Channel



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This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

Features

- 2.5V drive
- 2kV ESD HBM
- Common-Drain Type
- ESD Diode-Protected Gate
- Pb-Free, Halogen Free and RoHS compliance

Applications

- 1-Cell Lithium-ion Battery Charging and Discharging Switch

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS at Ta = 25°C (Note 1)

| Parameter | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Source to Source Voltage | V _{SSS} | 12 | V |
| Gate to Source Voltage | V _{GSS} | ±8 | V |
| Source Current (DC) | I _S | 27 | A |
| Source Current (Pulse) PW≤100μs, duty cycle≤1% | I _{SP} | 100 | A |
| Total Dissipation Surface mounted on ceramic substrate (5000mm ² × 0.8mm) | P _T | 2.5 | W |
| Junction Temperature | T _J | 150 | °C |
| Storage Temperature | T _{stg} | -55 to +150 | °C |

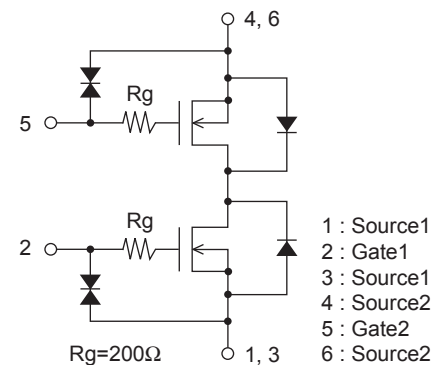
Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Value | Unit |
|--|------------------|-------|------|
| Junction to Ambient Surface mounted on ceramic substrate (5000mm ² × 0.8mm) | R _{θJA} | 50 | °C/W |

| V _{SSS} | R _{SS(on)} Max | I _S Max |
|------------------|-------------------------|--------------------|
| 12V | 3.2mΩ@ 4.5V | 27A |
| | 3.2mΩ@ 4.0V | |
| | 3.2mΩ@ 3.8V | |
| | 4.4mΩ@ 3.1V | |
| | 6.3mΩ@ 2.5V | |

ELECTRICAL CONNECTION N-Channel



CSP6, 1.77x3.54 /
EFCP3517-6DGH-020

MARKING



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

EFC6611R

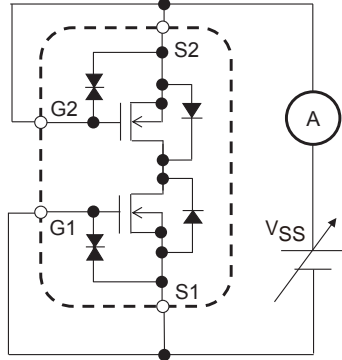
ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 2)

| Parameter | Symbol | Conditions | Value | | | Unit |
|---|----------|---|-------|--------|-----|------|
| | | | min | typ | max | |
| Source to Source Breakdown Voltage | V(BR)SSS | IS=1mA, VGS=0V Test Circuit 1 | 12 | | | V |
| Zero-Gate Voltage Source Current | ISSS | VSS=10V, VGS=0V Test Circuit 1 | | | 1 | μA |
| Gate to Source Leakage Current | IGSS | VGS=±8V, VSS=0V Test Circuit 2 | | | ±1 | μA |
| Gate Threshold Voltage | VGS(th) | VSS=6V, IS=1mA Test Circuit 3 | 0.5 | | 1.3 | V |
| Forward Transconductance | gFS | VSS=6V, IS=3A Test Circuit 4 | | 19 | | S |
| Static Source to Source On-State Resistance | RSS(on)1 | IS=5A, VGS=4.5V Test Circuit 5 | 1.8 | 2.3 | 3.2 | mΩ |
| | RSS(on)2 | IS=5A, VGS=4.0V Test Circuit 5 | 1.9 | 2.4 | 3.2 | mΩ |
| | RSS(on)3 | IS=5A, VGS=3.8V Test Circuit 5 | 2.0 | 2.6 | 3.2 | mΩ |
| | RSS(on)4 | IS=5A, VGS=3.1V Test Circuit 5 | 2.1 | 3.3 | 4.4 | mΩ |
| | RSS(on)5 | IS=5A, VGS=2.5V Test Circuit 5 | 2.7 | 4.0 | 6.3 | mΩ |
| Turn-ON Delay Time | td(on) | VSS=6V, VGS=4.5V, IS=3A Test Circuit 6 | | 80 | | ns |
| Rise Time | tr | | | 570 | | ns |
| Turn-OFF Delay Time | td(off) | | | 38,000 | | ns |
| Fall Time | tf | | | 17,700 | | ns |
| Total Gate Charge | Qg | VSS=6V, VGS=4.5V, IS=27A Test Circuit 7 | | 100 | | nC |
| Forward Source to Source Voltage | VF(S-S) | IS=3A, VGS=0V Test Circuit 8 | | 0.75 | 1.2 | V |

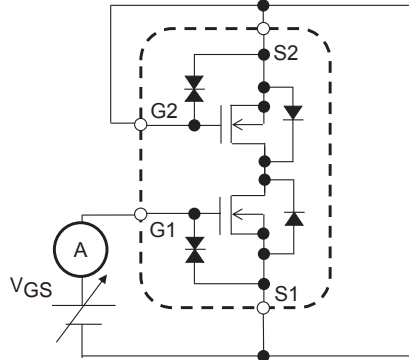
Note 2 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test circuits are example of measuring FET1 side

Test Circuit 1
VSSS / ISSS

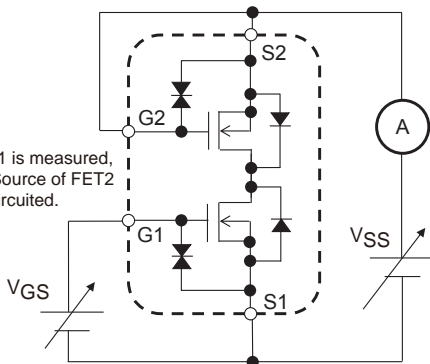


Test Circuit 2
IGSS



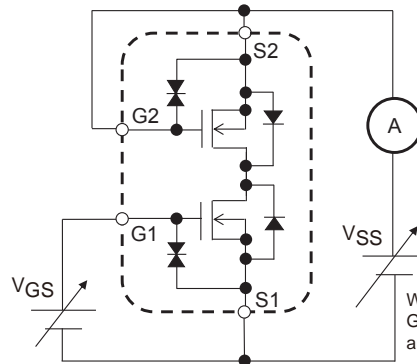
When FET1 is measured, Gate and Source of FET2 are short-circuited.

Test Circuit 3
VGS(th)



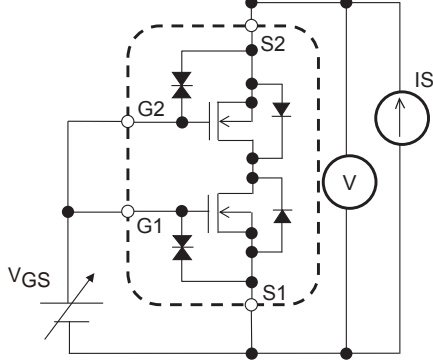
When FET1 is measured, Gate and Source of FET2 are short-circuited.

Test Circuit 4
gFS

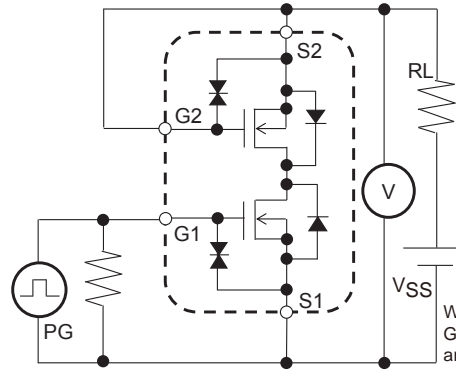


When FET1 is measured, Gate and Source of FET2 are short-circuited.

Test Circuit 5
RSS(on)

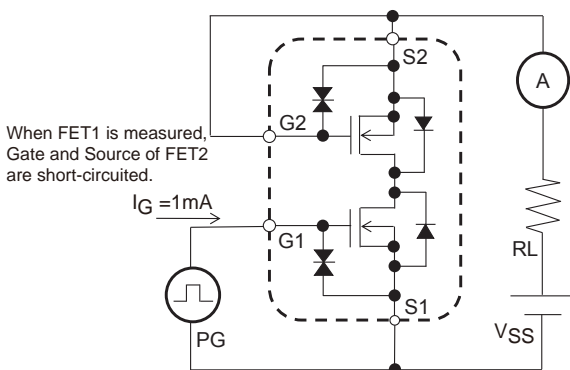


Test Circuit 6
td(on), tr, td(off), tf



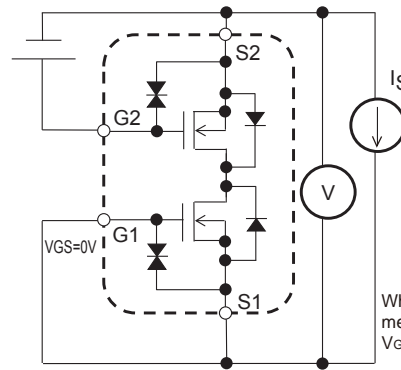
When FET1 is measured, Gate and Source of FET2 are short-circuited.

Test Circuit 7
Qg



When FET1 is measured, Gate and Source of FET2 are short-circuited.

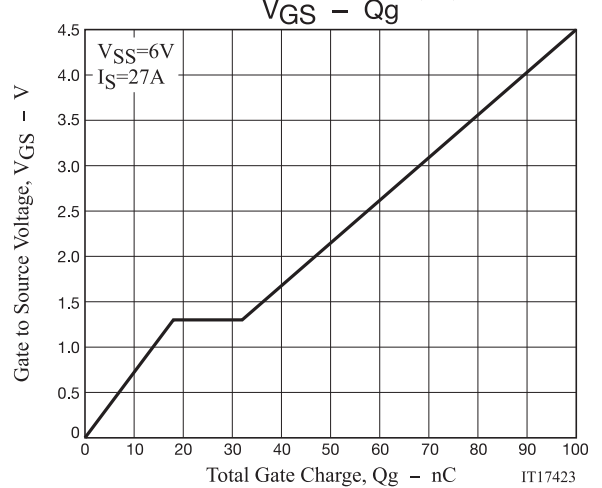
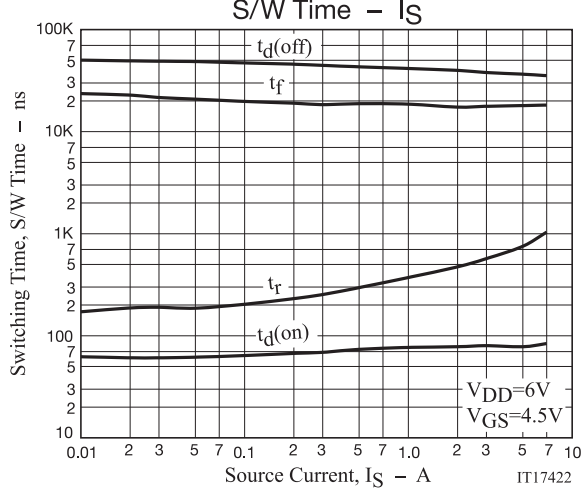
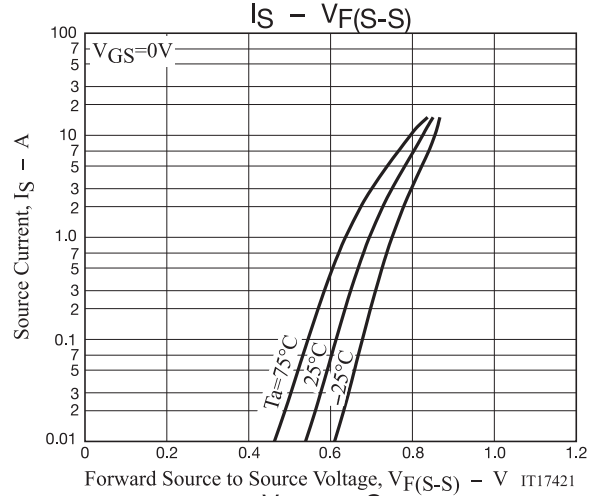
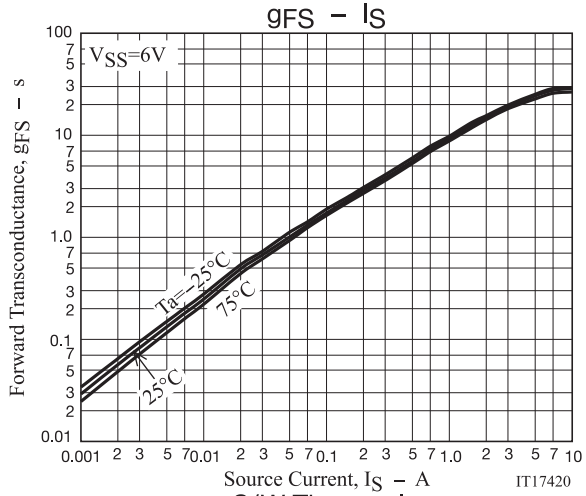
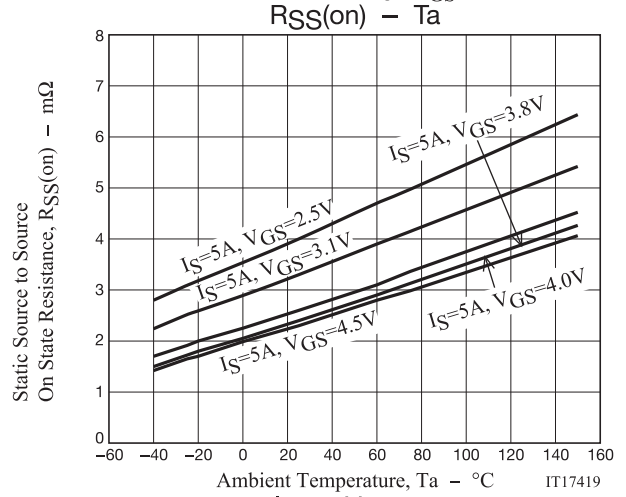
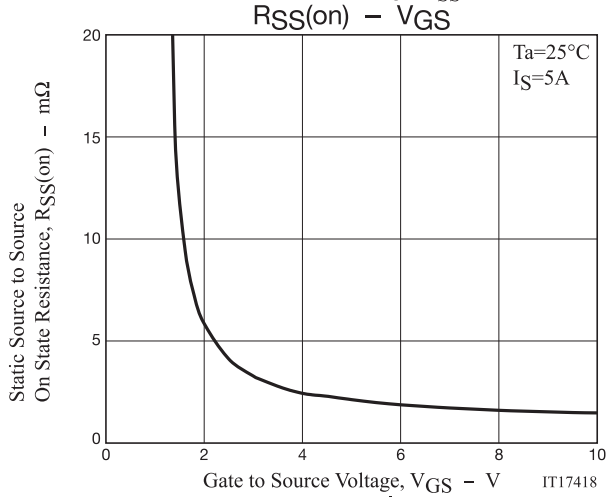
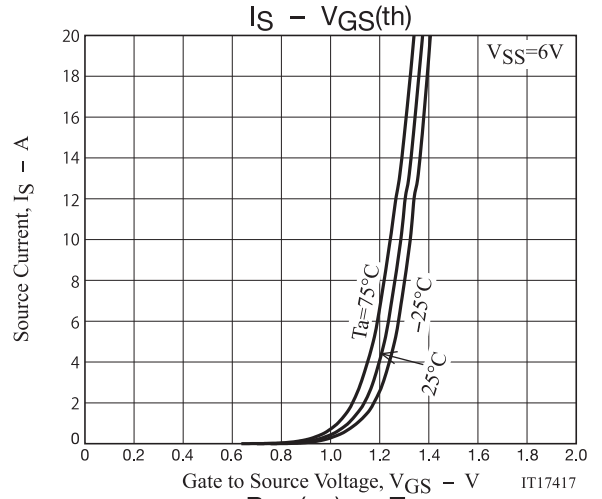
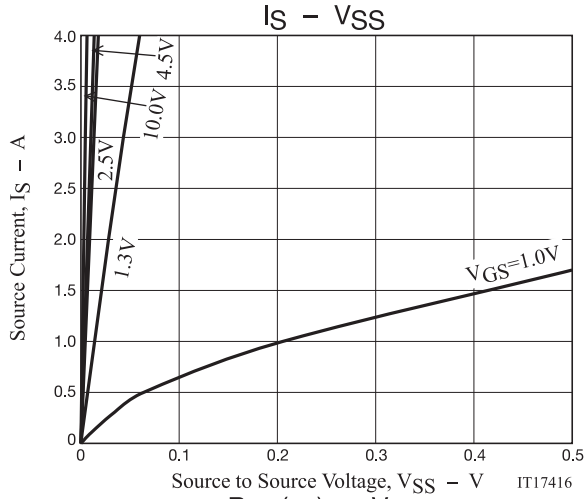
Test Circuit 8
VF(S-S)



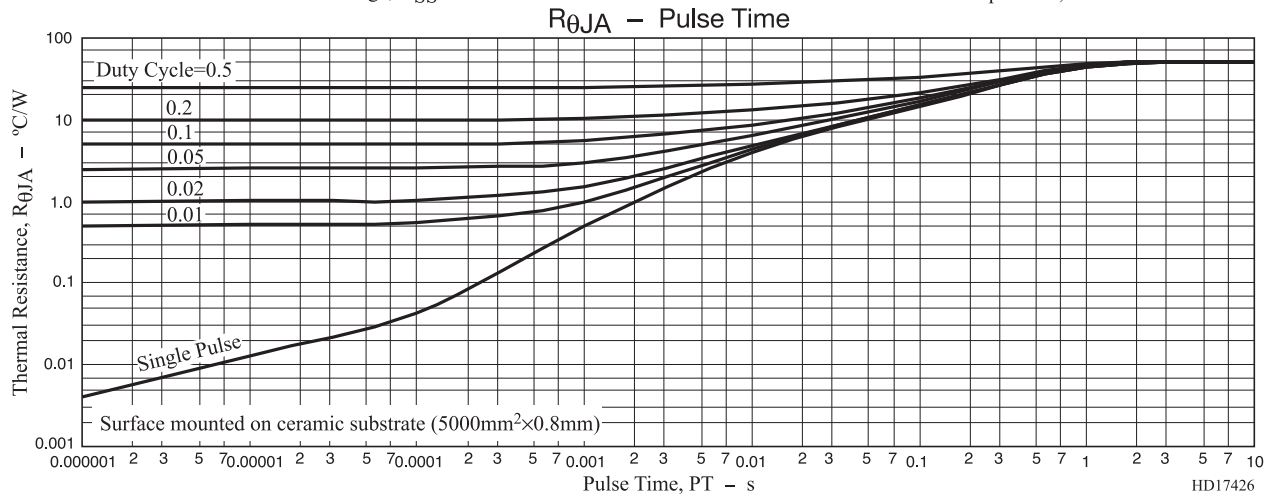
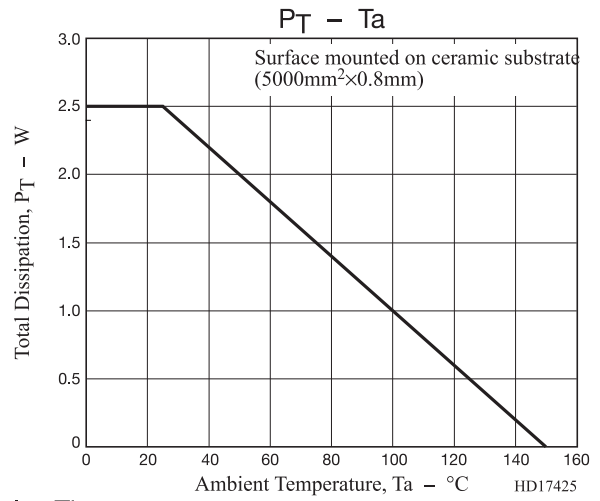
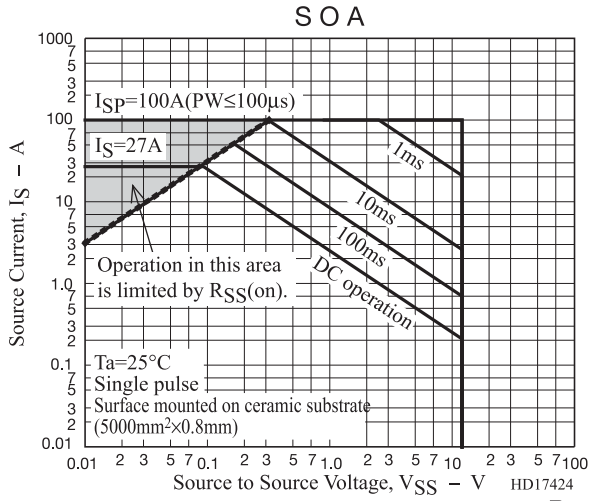
When FET1 is measured, +4.5V is added to Vgs of FET2.

When FET2 is measured, the position of FET1 and FET2 is switched.

EFC6611R



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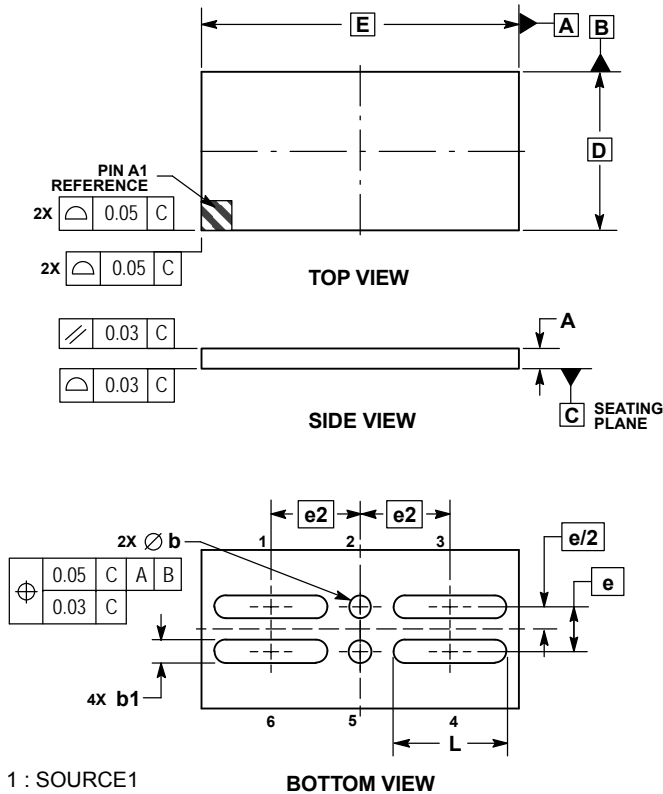


EFC6611R

PACKAGE DIMENSIONS

unit : mm

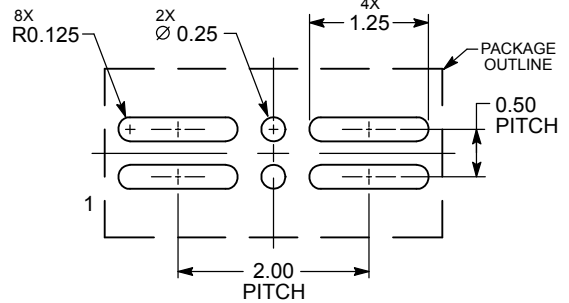
CSP6, 1.77x3.54 / EFCP3517-6DGH-020
CASE 568AL
ISSUE O



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.

| DIM | MILLIMETERS | |
|-----|-------------|------|
| | MIN | MAX |
| A | --- | 0.22 |
| b | 0.22 | 0.28 |
| b1 | 0.22 | 0.28 |
| D | 1.77 BSC | |
| E | 3.54 BSC | |
| e | 0.50 BSC | |
| e2 | 1.00 BSC | |
| L | 1.22 | 1.28 |

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ORDERING INFORMATION

| Device | Marking | Package | Shipping (Qty / Packing) |
|-------------|---------|--|--------------------------|
| EFC6611R-TF | ML | CSP6, 1.77x3.54 / EFCP3517-6DGH-020 (Pb-Free / Halogen Free) | 5,000 / Tape & Reel |

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage : Since the EFC6611R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

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